Electronic Patent Application Fee Transmittal							
Application Number:	10	10791037					
Filing Date:	02-Mar-2004						
Title of Invention:	SYSTEM AND METHOD FOR FORMING MOLD CAPS OVER INTEGRATED CIRCUIT DEVICES						
First Named Inventor/Applicant Name:	Yo	Yoshimi Takahashi					
Filer:	Yir	Yingsheng Tung/Jackie McBride					
Attorney Docket Number:	TI-	TI-37029 (032350.B586)					
Filed as Large Entity	•						
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1400	1400		
Publ. Fee- early, voluntary, or normal		1504	1	300	300		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1700